

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KYEONGWEON LEE	02/06/2015
SEONGHO HA	02/06/2015
WONHYUN JUNG	02/06/2015
RECEIVING PARTY DATA	
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Street Address:	128, YEQUI-DAERO, YEONGDEUNGPO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	150-721
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14645556
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NAME OF SUBMITTER:	DANIEL Y.J. KIM
SIGNATURE:	/Daniel Y.J. Kim/
DATE SIGNED:	03/12/2015
Total Attachments: 1 source=Assignment#page1.tif	

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- (1) Kyeongweon LEE (4) _____
- (2) Seongho HA (5) _____
- (3) Wonhyun JUNG (6) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto

LG ELECTRONICS INC.
128, Yeoui-daero, Yeongdeungpo-gu
Seoul, 150-721 Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

COOLING SYSTEM AND REFRIGERATOR INCLUDING A COOLING SYSTEM

(a) for which an application for United States Letters Patent was filed on _____, and identified by United States Serial No. _____; or


(b) for which an application for United States Letters Patent was executed on February 6, 2015

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and/or that claim priority thereto and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof and/or that claim priority thereto, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

AND the undersigned hereby grants the firm of KED & ASSOCIATES, LLP the power to insert on this assignment any further identification that may be necessary or desirable in order to comply with the rules of any issuing authority, including the United States Patent and Trademark Office, for recordation of this document.

SIGNED on the dates indicated aside our signatures:

INVENTORS	DATE SIGNED
1) <u>K. W. Lee</u> Name: Kyeongweon LEE	<u>6. Feb. 2015</u>
2)  Name: Seongho HA	<u>6. Feb. 2015</u>
3) <u>Jung Won Hyun</u> Name: Wonhyun JUNG	<u>6. Feb. 2015</u>
4) _____ Name: _____	_____
5) _____ Name: _____	_____
6) _____ Name: _____	_____